

AX500-2FG676I

AX500-2FG676I Information

www.lieisepcoom	www.basep.com		AX500-2FG676I Microsemi Corporation Integrated Circuits (ICs) Embedded - FPGAs (Field Programmable Gate	
		Description Package	Array) IC FPGA 336 I/O 676FBGA 676-BGA	
	For Reference Only		For the pricing/inventory/lead time, please contact us Website: https://www.heisener.com E-mail: salesdept@heisener.com	Request a Quote

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.



AX500-2FG676I Specifications

Manufacturer Part Number	AX500-2FG676I
Manufacturer	Microsemi Corporation
Category	Integrated Circuits (ICs)
	Embedded - FPGAs (Field Programmable Gate Array)
Package	676-BGA
Series	Axcelerator
Number of LABs/CLBs	8064
Number of Logic Elements/Cells	-
Total RAM Bits	73728
Number of I/O	336
Number of Gates	500000
Voltage - Supply	1.425 V ~ 1.575 V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 85°C (TA)
Package / Case	676-BGA
Supplier Device Package	676-FBGA (27x27)
	Report errors?

AX500-2FG676I Guarantees



Quality Guarantees

We provide 90 days warranty. * If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.

SERVICE

Service Guarantees

We guarantee 100% customer satisfaction. Our experienced sales team and tech support team back our services to satisfy all our customers.

AX500-2FG676I Payment Methods





If you have any question about AX500-2FG676I, please do not hesitate to contact us! Website: https://www.heisener.com E-mail: salesdept@heisener.com